This information is based on data and tests believed to be accurate. Epoxy Technology, Inc. makes no warranties (expressed or implied) as to its accuracy and assumes no liability in connection with any use of this product.

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www.epotek.com

# Product Information Sheet

## EPO-TEK® H20E-PFC-D

<table>
<thead>
<tr>
<th>Date:</th>
<th>September 2017</th>
</tr>
</thead>
<tbody>
<tr>
<td>Rev:</td>
<td>IV</td>
</tr>
<tr>
<td>No. of Components:</td>
<td>Single</td>
</tr>
<tr>
<td>Mix Ratio by Weight:</td>
<td>N/A</td>
</tr>
<tr>
<td>Specific Gravity:</td>
<td>3.48</td>
</tr>
<tr>
<td>Pot Life:</td>
<td>3 Days</td>
</tr>
<tr>
<td>Shelf Life- Bulk:</td>
<td>One year at -40°C</td>
</tr>
</tbody>
</table>

**NOTES:**
- Container(s) should be kept closed when not in use.
- Filled systems should be stirred thoroughly before mixing and prior to use.
- Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.

**Product Description:** A single component, semiconductor-grade epoxy designed for improved dispensing.

**Typical Properties:** Cure condition: 150°C / 1 Hour  Different batches, conditions & applications yield differing results.  Data below is not guaranteed.  To be used as a guide only, not as a specification.  * denotes test on lot acceptance basis

## PHYSICAL PROPERTIES:

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Color (before cure)</td>
<td>Silver</td>
</tr>
<tr>
<td>Consistency</td>
<td>Thixotropic paste</td>
</tr>
<tr>
<td>Viscosity (23°C) @ 50 rpm</td>
<td>2,000 - 4,000 cPs</td>
</tr>
<tr>
<td>Thixotropic Index</td>
<td>4.3</td>
</tr>
<tr>
<td>Glass Transition Temp:</td>
<td>≥ 70 °C</td>
</tr>
<tr>
<td>Coefficient of Thermal Expansion (CTE):</td>
<td></td>
</tr>
<tr>
<td>Below Tg:</td>
<td>51 x 10^-6 in/in°C</td>
</tr>
<tr>
<td>Above Tg:</td>
<td>99 x 10^-6 in/in°C</td>
</tr>
<tr>
<td>Shore D Hardness</td>
<td>50</td>
</tr>
<tr>
<td>Lap Shear @ 23°C</td>
<td>1,072 psi</td>
</tr>
<tr>
<td>Die Shear @ 23°C</td>
<td>≥ 10 Kg 3,556 psi</td>
</tr>
<tr>
<td>Degradation Temp</td>
<td>400 °C</td>
</tr>
<tr>
<td>Weight Loss:</td>
<td></td>
</tr>
<tr>
<td>@ 200°C:</td>
<td>0.79 %</td>
</tr>
<tr>
<td>@ 250°C:</td>
<td>1.46 %</td>
</tr>
<tr>
<td>@ 300°C:</td>
<td>2.08 %</td>
</tr>
<tr>
<td>Suggested Operating Temperature:</td>
<td>&lt; 350 °C (Intermittent)</td>
</tr>
<tr>
<td>Storage Modulus</td>
<td>1,505,970 psi</td>
</tr>
<tr>
<td>Ion Content:</td>
<td>CI⁻: 199 ppm Na⁺: 12 ppm NH₄⁺: 349 ppm K⁺: 12 ppm</td>
</tr>
<tr>
<td>* Particle Size:</td>
<td>≤ 20 microns</td>
</tr>
</tbody>
</table>

## ELECTRICAL AND THERMAL PROPERTIES:

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Thermal Conductivity</td>
<td>N/A</td>
</tr>
<tr>
<td>* Volume Resistivity @ 23°C</td>
<td>≤ 0.0005 Ohm-cm</td>
</tr>
</tbody>
</table>